D1MNAB13H

Pb RoHS

650V N-Channel MOSFETs

General Description

The D1MNAB13H is a high voltage power MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristic.

This power MOSFET is usually used in high speed switching applications of switching power supplies and adaptors.

BV_{DSS}	$R_{DS(ON)}$	I_D
650 V	1.3 Ω	7 A

TO-252 Pin Configuration
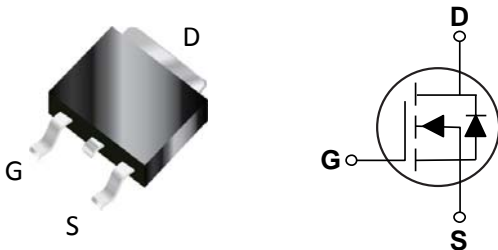
Features

· $R_{DS(ON)} \leqq 1.3\,Ω$ @V_{GS}=10V
· Fast switching capability
· Avalanche energy tested
· Improved dv/dt capability

Absolute Maximum Ratings T_C=25°C unless otherwise noted

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	650	V
V_{GS}	Gate-Source Voltage	±30	V
I_D	Drain Current - Continuous	7	A
I_{DM}	Drain Current - Pulsed (NOTE 2)	14	A
E_{AS}	Single Pulse Avalanche Energy (NOTE 3)	281.3	mJ
P_D	Power Dissipation	48	W
T_J	Operating Junction Temperature Range	-50 to 150	^{o}C
T_{STG}	Storage Temperature Range	-50 to 150	^{o}C
Marking Code		NAB13H	

NOTES：

1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

　　Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. L=10mH, I_{AS}=7.5A, V_{DD}=50V, R_G=25Ω, Starting T_J= 25°C

Thermal Characteristics

| Symbol	Parameter	Typ.	Max.	Unit
$R_{θJA}$	Thermal Resistance Junction to Ambient	---	100	^{o}C/W
$R_{θJC}$	Thermal Resistance Junction to Case	---	2.6	^{o}C/W

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Electrical Characteristics (T_J=25°C, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V , I_D=250uA	650	---	---	V
I_{DSS}	Drain-Source Leakage Current	V_{DS}=650V , V_{GS}=0V	---	---	10	uA
I_{GSS}	Gate-Source Leakage Current	V_{GS}=±30V , V_{DS}=0V	---	---	±100	nA

On Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$R_{DS(ON)}$	Static Drain-Source On-Resistance	V_{GS}=10V , I_D=3.5A	---	---	1.3	Ω
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS}=V_{DS} , I_D=250uA	2.0	---	4.0	V

Dynamic and switching Characteristics (NOTE3)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
Q_g	Total Gate Charge	V_{DS}=520V , V_{GS}=10V , I_D=7A , I_G=1mA (NOTE 4 、5)	---	22	---	nC
Q_{gs}	Gate-Source Charge		---	5	---	
Q_{gd}	Gate-Drain Charge		---	5.5	---	
$T_{d(on)}$	Turn-On Delay Time	V_{DS}=100V , V_{GS}=10V , R_G=25Ω , I_D=7A (NOTE 4 、5)	---	12	---	nS
T_r	Rise Time		---	20	---	
$T_{d(off)}$	Turn-Off Delay Time		---	74	---	
T_f	Fall Time		---	33	---	
C_{iss}	Input Capacitance	V_{DS}=25V , V_{GS}=0V , f=1MHz	---	870	---	pF
C_{oss}	Output Capacitance		---	97	---	
C_{rss}	Reverse Transfer Capacitance		---	9.6	---	

Drain-Source Diode Characteristics and Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Maximum Body-Diode Continuous Current		---	---	7	A
I_{SM}	Maximum Body-Diode Pulsed Current		---	---	14	A
V_{SD}	Diode Forward Voltage (NOTE 4)	V_{GS}=0V , I_S=7A	---	---	1.4	V
trr	Reverse Recovery Time	I_S=7A , V_{GS}=0V , di/dt=100A/µs	---	506	---	nS
Qrr	Reverse Recovery Charge		---	2.7	---	uC

NOTES：

4. Pulse test：pulse width ≦ 300us , duty cycle ≦ 2%.

5. Essentially independent of operating temperature.

Test Circuits And Waveforms

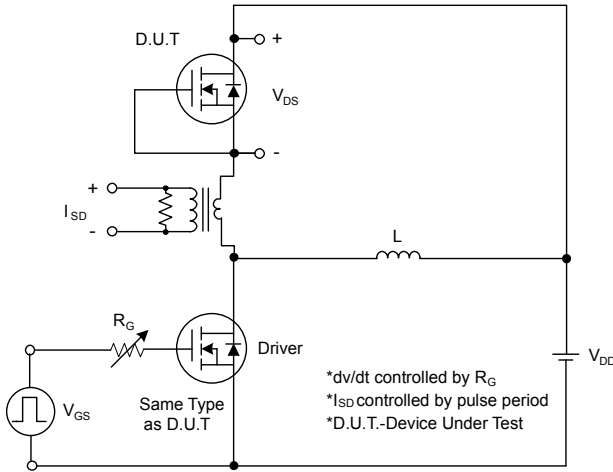### FIG. 1-Peak Diode Recovery dv/dt Test Circuit

*dv/dt controlled by R_G
*I_{SD} controlled by pulse period
*D.U.T.-Device Under Test

FIG. 2-Peak Diode Recovery dv/dt Waveforms

FIG. 3-Switching Test Circuit
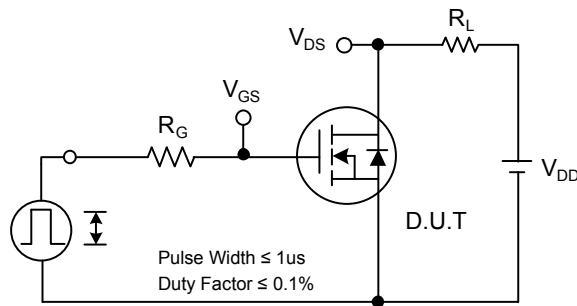

Pulse Width ≤ 1us
Duty Factor ≤ 0.1%
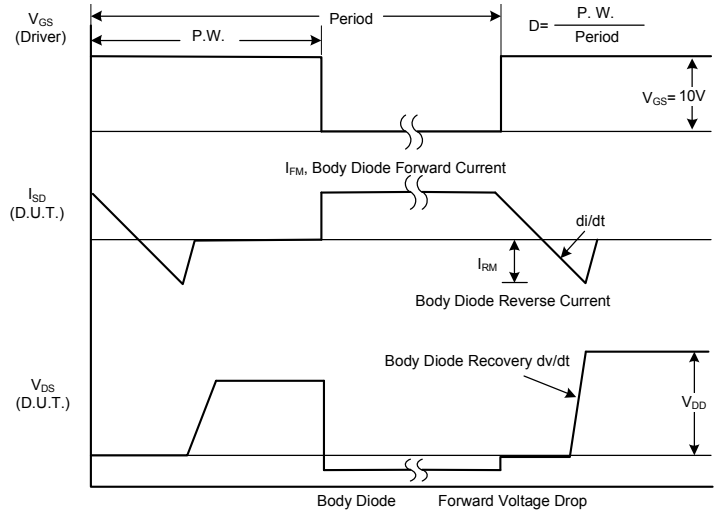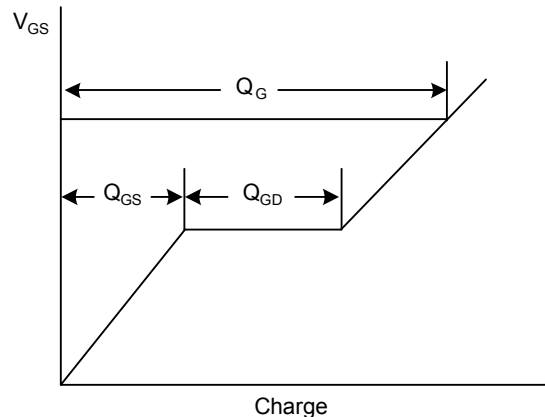
FIG. 4-Switching Waveforms
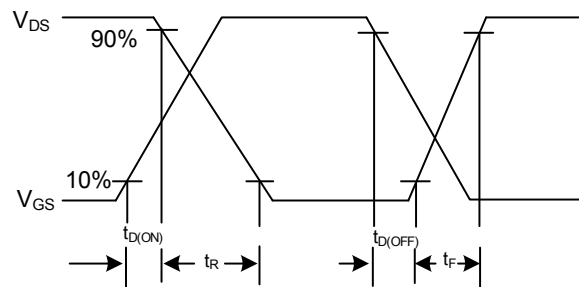
FIG. 5-Gate Charge Test Circuit
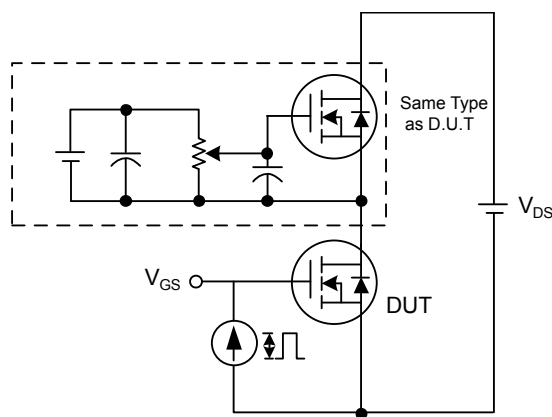
FIG. 6-Gate Charge Waveform

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Test Circuits And Waveforms

FIG. 7-Unclamped Inductive Switching Test Circuit
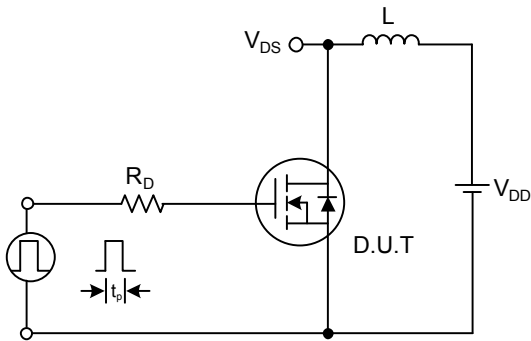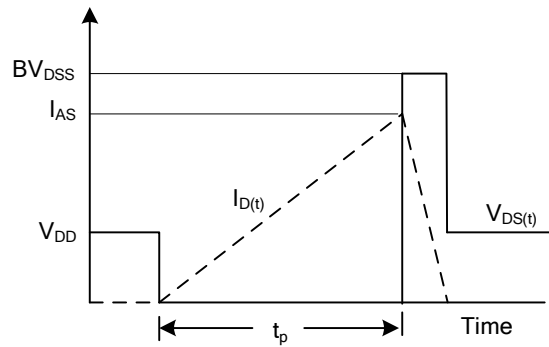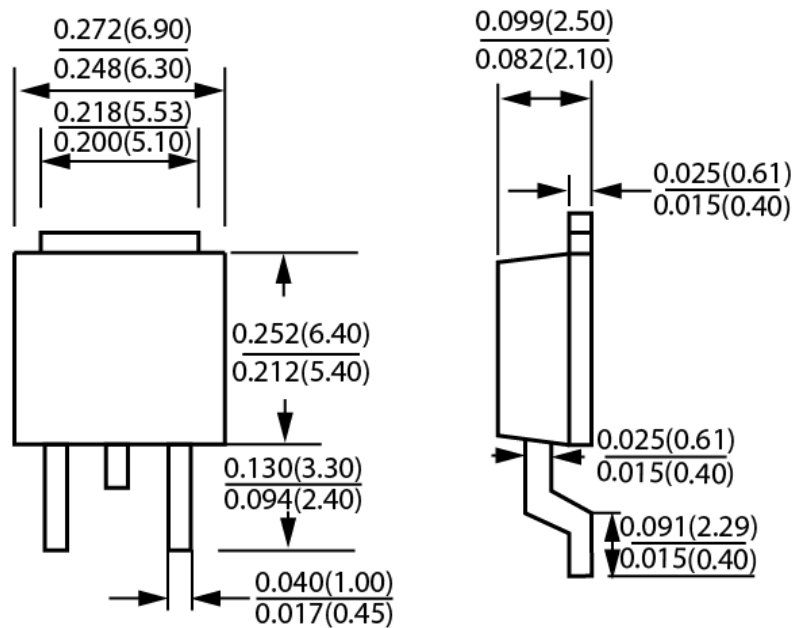
FIG. 8-Unclamped Inductive Switching Waveforms

Package Outline Dimensions

TO-252

Dimensions in inches and (millimeters)

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